

74AHC139; 74AHCT139

Dual 2-to-4 line decoder/demultiplexer

Rev. 02 — 9 May 2008

Product data sheet

1. General description

The 74AHC139; 74AHCT139 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7-A.

The 74AHC139; 74AHCT139 is a high-speed, dual 2-to-4 line decoder/demultiplexer. This device has two independent decoders, each accepting two binary weighted inputs ($nA0$ and $nA1$) and providing four mutually exclusive active LOW outputs ($n\bar{Y}0$ to $n\bar{Y}3$). Each decoder has an active LOW enable input ($n\bar{E}$). When $n\bar{E}$ is HIGH, every output is forced HIGH. The enable input can be used as the data input for a 1-to-4 demultiplexer application.

The 74AHC139; 74AHCT139 is identical to the HEF4556 of the HE4000B family.

2. Features

- Balanced propagation delays
- All inputs have Schmitt-trigger actions
- Inputs accept voltages higher than V_{CC}
- Input levels:
 - ◆ For 74AHC139: CMOS level
 - ◆ For 74AHCT139: TTL level
- ESD protection:
 - ◆ HBM EIA/JESD22-A114E exceeds 2000 V
 - ◆ MM EIA/JESD22-A115-A exceeds 200 V
 - ◆ CDM EIA/JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from -40 °C to $+85\text{ °C}$ and from -40 °C to $+125\text{ °C}$

3. Ordering information

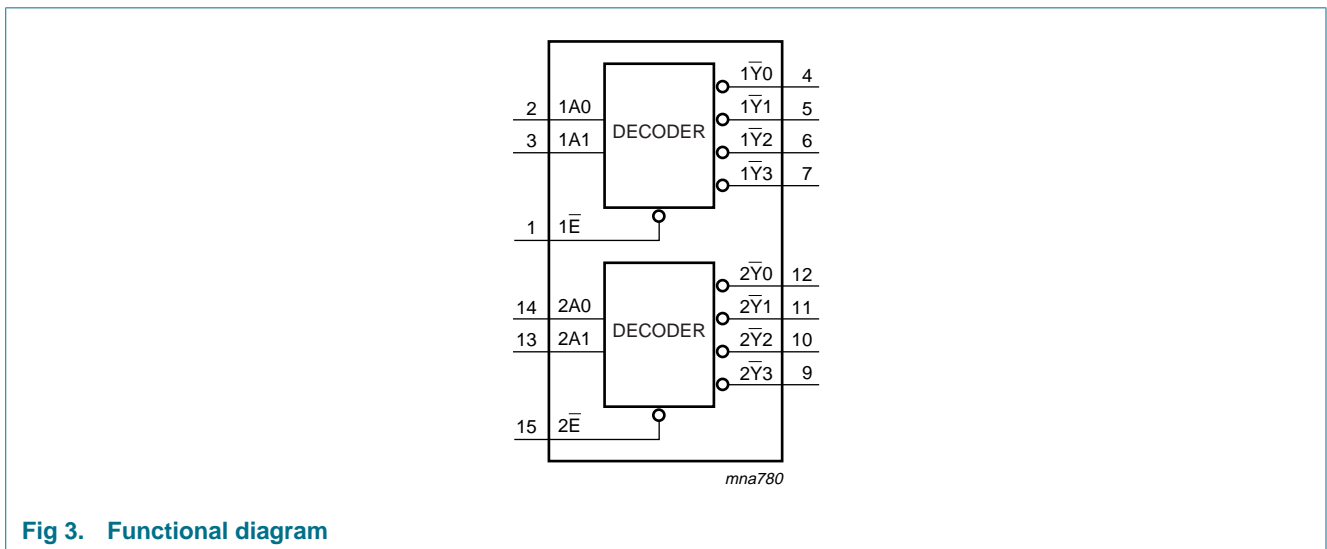
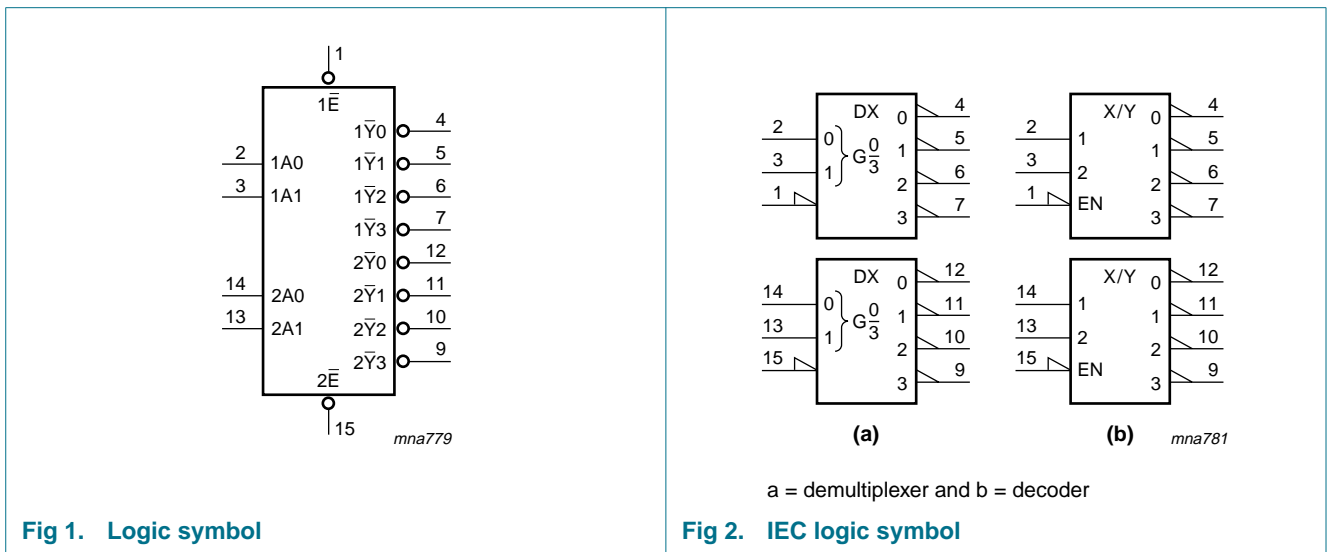
Table 1. Ordering information

| Type number | Package | | | |
|-----------------|-------------------------------------|---------|---|----------|
| | Temperature range | Name | Description | Version |
| 74AHC139 | | | | |
| 74AHC139D | -40 °C to $+125\text{ °C}$ | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| 74AHC139PW | -40 °C to $+125\text{ °C}$ | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |

Table 1. Ordering information ...continued

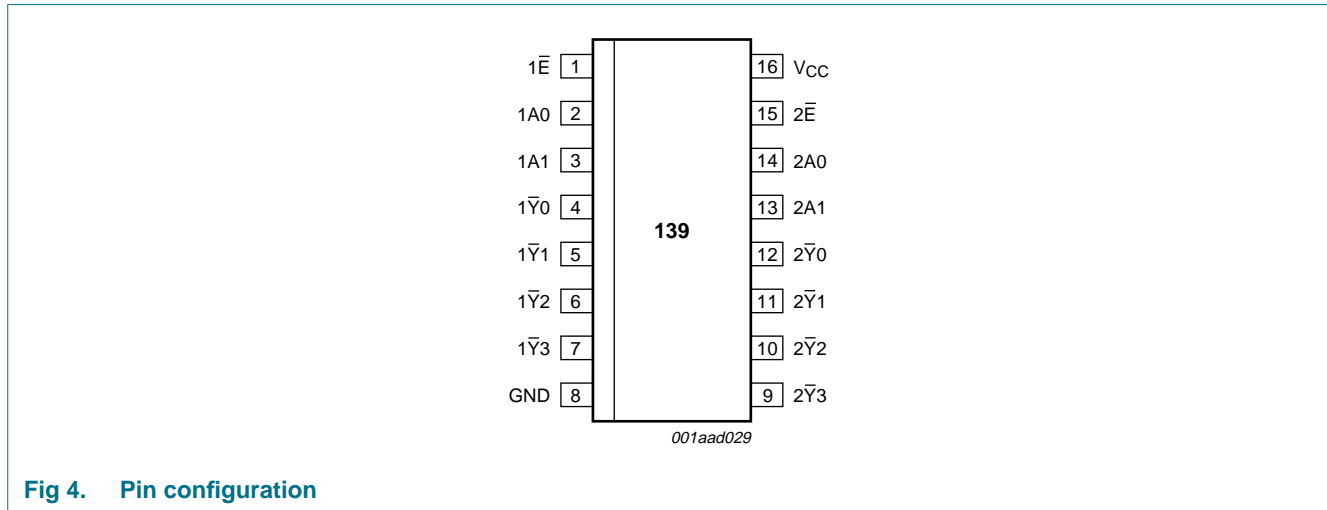
| Type number | Package | | | Version |
|------------------|-------------------|---------|---|----------|
| | Temperature range | Name | Description | |
| 74AHCT139 | | | | |
| 74AHCT139D | -40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| 74AHCT139PW | -40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|-----|---------------------------|
| $1\bar{E}$ | 1 | enable input (active LOW) |
| 1A0 | 2 | address input |
| 1A1 | 3 | address input |
| $1\bar{Y}0$ | 4 | output |
| $1\bar{Y}1$ | 5 | output |
| $1\bar{Y}2$ | 6 | output |
| $1\bar{Y}3$ | 7 | output |
| GND | 8 | ground (0 V) |
| $2\bar{Y}3$ | 9 | output |
| $2\bar{Y}2$ | 10 | output |
| $2\bar{Y}1$ | 11 | output |
| $2\bar{Y}0$ | 12 | output |
| 2A1 | 13 | address input |
| 2A0 | 14 | address input |
| $2\bar{E}$ | 15 | enable input (active LOW) |
| V _{CC} | 16 | supply voltage |

6. Functional description

Table 3. Function table^[1]

| Control \overline{nE} | Input | | Output | | | |
|----------------------------|-------|-----|------------------|------------------|------------------|------------------|
| | nA0 | nA1 | $\overline{nY0}$ | $\overline{nY1}$ | $\overline{nY2}$ | $\overline{nY3}$ |
| H | X | X | H | H | H | H |
| L | L | L | L | H | H | H |
| | H | L | H | L | H | H |
| | L | H | H | H | L | H |
| | H | H | H | H | H | L |

- [1] H = HIGH voltage level;
L = LOW voltage level;
X = don't care.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--|--------------------|------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| V_I | input voltage | | -0.5 | +7.0 | V |
| I_{IK} | input clamping current | $V_I < -0.5$ V | ^[1] -20 | - | mA |
| I_{OK} | output clamping current | $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V | ^[1] -20 | +20 | mA |
| I_O | output current | $V_O = -0.5$ V to $(V_{CC} + 0.5$ V) | -25 | +25 | mA |
| I_{CC} | supply current | | - | +75 | mA |
| I_{GND} | ground current | | -75 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40$ °C to +125 °C | ^[2] - | 500 | mW |

- [1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.
For TSSOP16 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.

8. Recommended operating conditions

Table 5. Operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------------|---|-----|-----|----------|------|
| 74AHC139 | | | | | | |
| V_{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | V |
| V_I | input voltage | | 0 | - | 5.5 | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | - | - | 100 | ns/V |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ | - | - | 20 | ns/V |
| 74AHCT139 | | | | | | |
| V_{CC} | supply voltage | | 4.5 | 5.0 | 5.5 | V |
| V_I | input voltage | | 0 | - | 5.5 | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ | - | - | 20 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|-----------------|---|---|-------|------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| 74AHC139 | | | | | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 2.0\text{ V}$ | 1.5 | - | - | 1.5 | - | 1.5 | - | V |
| | | $V_{CC} = 3.0\text{ V}$ | 2.1 | - | - | 2.1 | - | 2.1 | - | V |
| | | $V_{CC} = 5.5\text{ V}$ | 3.85 | - | - | 3.85 | - | 3.85 | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 2.0\text{ V}$ | - | - | 0.5 | - | 0.5 | - | 0.5 | V |
| | | $V_{CC} = 3.0\text{ V}$ | - | - | 0.9 | - | 0.9 | - | 0.9 | V |
| | | $V_{CC} = 5.5\text{ V}$ | - | - | 1.65 | - | 1.65 | - | 1.65 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | | | | | |
| | | $I_O = -50\ \mu\text{A}; V_{CC} = 2.0\text{ V}$ | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | $I_O = -50\ \mu\text{A}; V_{CC} = 3.0\text{ V}$ | 2.9 | 3.0 | - | 2.9 | - | 2.9 | - | V |
| | | $I_O = -50\ \mu\text{A}; V_{CC} = 4.5\text{ V}$ | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_O = -4.0\text{ mA}; V_{CC} = 3.0\text{ V}$ | 2.58 | - | - | 2.48 | - | 2.40 | - | V |
| | $I_O = -8.0\text{ mA}; V_{CC} = 4.5\text{ V}$ | 3.94 | - | - | 3.80 | - | 3.70 | - | V | |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | | | | | |
| | | $I_O = 50\ \mu\text{A}; V_{CC} = 2.0\text{ V}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 50\ \mu\text{A}; V_{CC} = 3.0\text{ V}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 50\ \mu\text{A}; V_{CC} = 4.5\text{ V}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 4.0\text{ mA}; V_{CC} = 3.0\text{ V}$ | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| | $I_O = 8.0\text{ mA}; V_{CC} = 4.5\text{ V}$ | - | - | 0.36 | - | 0.44 | - | 0.55 | V | |

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|------------------|---------------------------|---|-------|-----|------|------------------|------|-------------------|------|---------------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| I_I | input leakage current | $V_I = 5.5 \text{ V}$ or GND; $V_{CC} = 0 \text{ V}$ to 5.5 V | - | - | 0.1 | - | 1.0 | - | 2.0 | μA |
| I_{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0 \text{ A}$; $V_{CC} = 5.5 \text{ V}$ | - | - | 4.0 | - | 40 | - | 80 | μA |
| C_I | input capacitance | $V_I = V_{CC}$ or GND | - | 3 | 10 | - | 10 | - | 10 | pF |
| C_O | output capacitance | | - | 4 | - | - | - | - | - | pF |
| 74AHCT139 | | | | | | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 4.5 \text{ V}$ to 5.5 V | 2.0 | - | - | 2.0 | - | 2.0 | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$ $I_O = -50 \mu\text{A}$ | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_O = -8.0 \text{ mA}$ | 3.94 | - | - | 3.80 | - | 3.70 | - | V |
| | | | | | | | | | | |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$ $I_O = 50 \mu\text{A}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 8.0 \text{ mA}$ | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| | | | | | | | | | | |
| I_I | input leakage current | $V_I = 5.5 \text{ V}$ or GND; $V_{CC} = 0 \text{ V}$ to 5.5 V | - | - | 0.1 | - | 1.0 | - | 2.0 | μA |
| I_{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0 \text{ A}$; $V_{CC} = 5.5 \text{ V}$ | - | - | 4.0 | - | 40 | - | 80 | μA |
| ΔI_{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1 \text{ V}$; other pins at V_{CC} or GND; $I_O = 0 \text{ A}$; $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | - | 1.35 | - | 1.5 | - | 1.5 | mA |
| C_I | input capacitance | $V_I = V_{CC}$ or GND | - | 3 | 10 | - | 10 | - | 10 | pF |
| C_O | output capacitance | | - | 4 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 7](#).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|--|---|---|-------|--------------------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ ^[1] | Max | Min | Max | Min | Max | |
| 74AHC139 | | | | | | | | | | |
| t_{pd} | propagation delay | nAn to n \bar{Y} n; see Figure 5 ^[2] | | | | | | | | |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | | | | | | | | |
| | | $C_L = 15\text{ pF}$ | - | 5.5 | 11.0 | 1.0 | 13.0 | 1.0 | 14.0 | ns |
| | | $C_L = 50\text{ pF}$ | - | 7.9 | 14.5 | 1.0 | 16.5 | 1.0 | 18.5 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ | | | | | | | | |
| | | $C_L = 15\text{ pF}$ | - | 3.9 | 7.2 | 1.0 | 8.5 | 1.0 | 9.0 | ns |
| | n \bar{E} to n \bar{Y} n; see Figure 6 ^[2] | $C_L = 50\text{ pF}$ | - | 5.6 | 9.2 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | | | | | | | | |
| | | $C_L = 15\text{ pF}$ | - | 4.8 | 9.2 | 1.0 | 11.0 | 1.0 | 11.5 | ns |
| | | $C_L = 50\text{ pF}$ | - | 6.9 | 12.7 | 1.0 | 14.5 | 1.0 | 16.0 | ns |
| | | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ | | | | | | | | |
| | | $C_L = 15\text{ pF}$ | - | 3.4 | 6.3 | 1.0 | 7.5 | 1.0 | 8.0 | ns |
| C_{PD} | power dissipation capacitance | $C_L = 50\text{ pF}$ | - | 4.9 | 8.3 | 1.0 | 9.5 | 1.0 | 10.5 | ns |
| | | $f_i = 1\text{ MHz}; V_I = \text{GND to }V_{CC}$ ^[3] | - | 26 | - | - | - | - | - | pF |
| 74AHCT139; $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ | | | | | | | | | | |
| t_{pd} | propagation delay | nAn to n \bar{Y} n; see Figure 5 ^[2] | | | | | | | | |
| | | $C_L = 15\text{ pF}$ | - | 4.7 | 7.2 | 1.0 | 8.5 | 1.0 | 9.0 | ns |
| | | $C_L = 50\text{ pF}$ | - | 6.5 | 9.2 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | n \bar{E} to n \bar{Y} n; see Figure 6 ^[2] | $C_L = 15\text{ pF}$ | - | 3.6 | 6.3 | 1.0 | 7.5 | 1.0 | 8.0 | ns |
| | | $C_L = 50\text{ pF}$ | - | 5.2 | 8.3 | 1.0 | 9.5 | 1.0 | 10.5 | ns |
| | | $f_i = 1\text{ MHz}; V_I = \text{GND to }V_{CC}$ ^[3] | - | 23 | - | - | - | - | - | pF |
| C_{PD} | power dissipation capacitance | $C_L = 15\text{ pF}$ | - | 3.6 | 6.3 | 1.0 | 7.5 | 1.0 | 8.0 | ns |
| | | $C_L = 50\text{ pF}$ | - | 5.2 | 8.3 | 1.0 | 9.5 | 1.0 | 10.5 | ns |

[1] Typical values are measured at nominal supply voltage ($V_{CC} = 3.3\text{ V}$ and $V_{CC} = 5.0\text{ V}$).

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

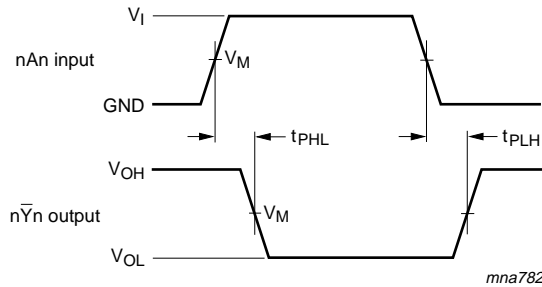
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

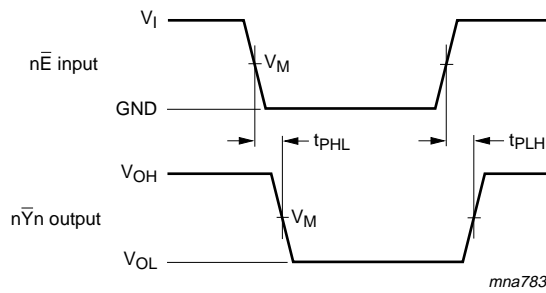
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

11. Waveforms



Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 5. Address input to output propagation delays

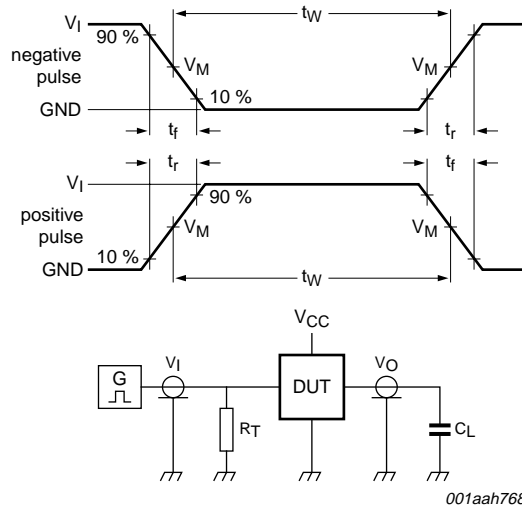


Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 6. Enable input to output propagation delays

Table 8. Measurement points

| Type | Input | Output |
|-----------|---------------------|---------------------|
| | V_M | V_M |
| 74AHC139 | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 74AHCT139 | 1.5 V | $0.5 \times V_{CC}$ |



001aah768

Test data is given in [Table 9](#).

Definitions test circuit:

R_T = termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = load capacitance including jig and probe capacitance.

Fig 7. Load circuitry for measuring switching times

Table 9. Test data

| Type | Input | | Load | Test |
|-----------|----------|---------------|--------------|--------------------|
| | V_I | t_r, t_f | C_L | |
| 74AHC139 | V_{CC} | ≤ 3.0 ns | 15 pF, 50 pF | t_{PLH}, t_{PHL} |
| 74AHCT139 | 3.0 V | ≤ 3.0 ns | 15 pF, 50 pF | t_{PLH}, t_{PHL} |

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

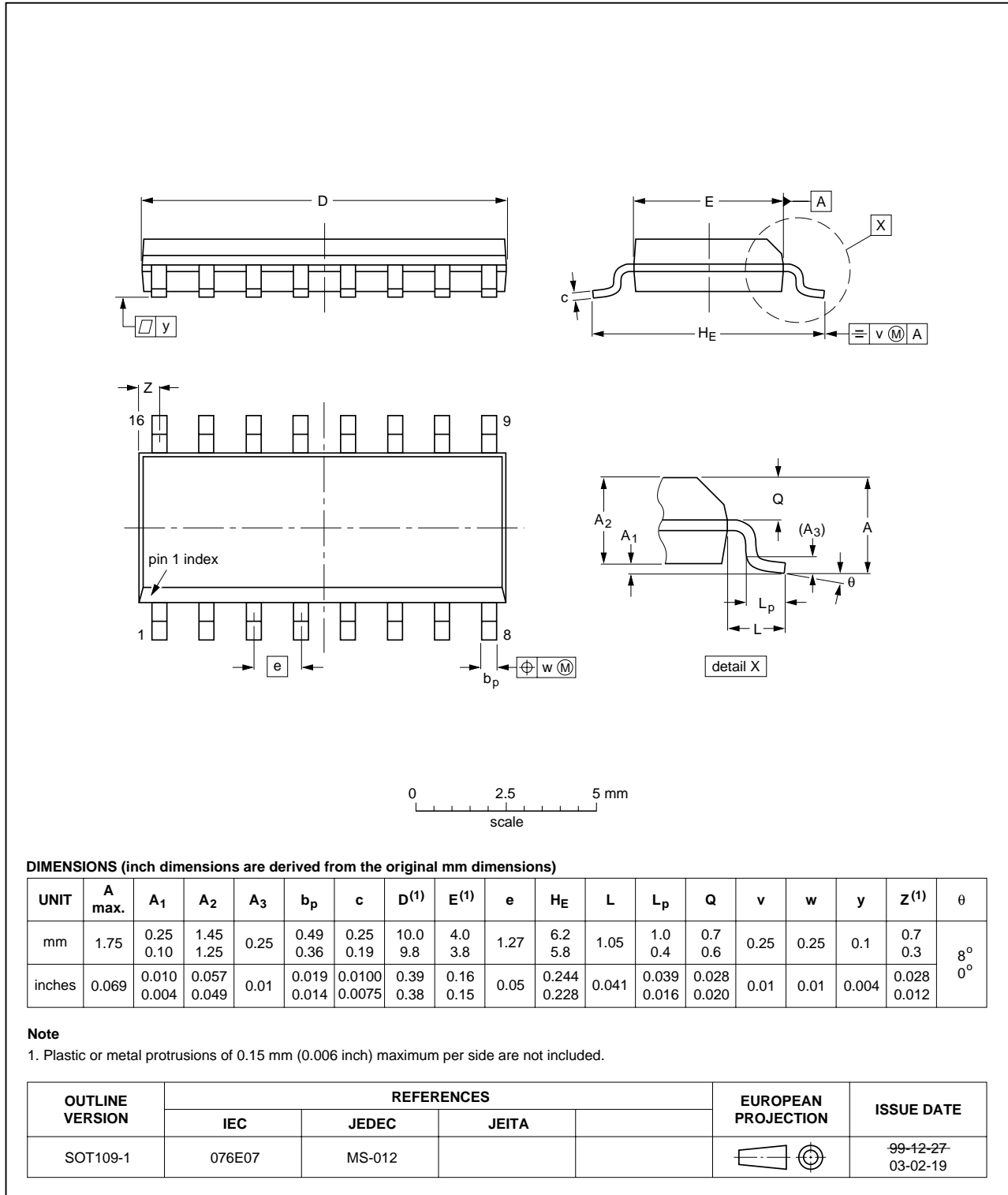


Fig 8. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

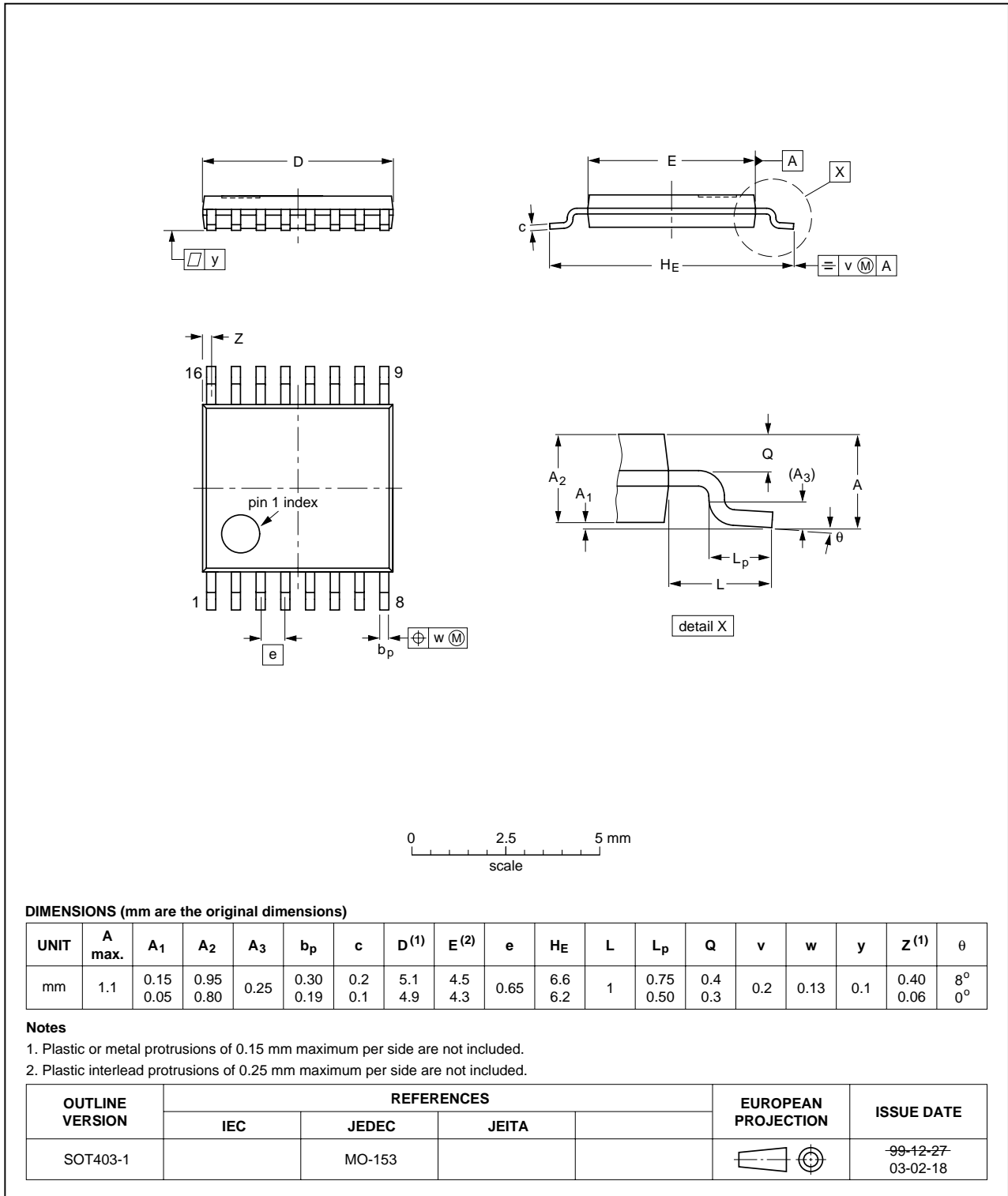


Fig 9. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|--|
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| LSTTL | Low-power Schottky Transistor-Transistor Logic |
| MM | Machine Model |

14. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|---|-----------------------|---------------|-----------------|
| 74AHC_AHCT139_2 | 20080509 | Product data sheet | - | 74AHC_AHCT139_1 |
| Modifications: | <ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Table 6: the conditions for input leakage current have been changed. | | | |
| 74AHC_AHCT139_1 | 19990901 | Product specification | - | - |

15. Legal information

15.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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17. Contents

| | | |
|-----------|---|-----------|
| 1 | General description | 1 |
| 2 | Features | 1 |
| 3 | Ordering information | 1 |
| 4 | Functional diagram | 2 |
| 5 | Pinning information | 3 |
| 5.1 | Pinning | 3 |
| 5.2 | Pin description | 3 |
| 6 | Functional description | 4 |
| 7 | Limiting values | 4 |
| 8 | Recommended operating conditions | 5 |
| 9 | Static characteristics | 5 |
| 10 | Dynamic characteristics | 7 |
| 11 | Waveforms | 8 |
| 12 | Package outline | 10 |
| 13 | Abbreviations | 12 |
| 14 | Revision history | 12 |
| 15 | Legal information | 13 |
| 15.1 | Data sheet status | 13 |
| 15.2 | Definitions | 13 |
| 15.3 | Disclaimers | 13 |
| 15.4 | Trademarks | 13 |
| 16 | Contact information | 13 |
| 17 | Contents | 14 |

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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